# Combined Effect of Thermoplastic and Thermosetting Adhesives on Properties of Particleboard With Rice Husk Core

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This study investigated the combined effect of adhesive type and content on the dimensional stability and mechanical properties of three-layer particleboards made from a mixture of wood particles (face layer: 30 wt %) and rice husk particles (core layer: 70 wt %). Two types of thermosetting adhesives, liquid urea-formaldehyde (UF) and phenol-formaldehyde (PF), and thermoplastic adhesive (low density polyethylene: LDPE) powder were used as binder in the experiments. Thickness swelling and water absorption of the particleboards significantly decreased with increasing content of the LDPE powder. The incorporation of LDPE powder into the core layer of particleboard greatly improved the internal bond strength.

**Keywords:** *dimensional stability, mechanical properties, phenol formaldehyde, urea-formaldehyde, thermoplastic adhesive, particleboard, rice husk* 

# 1. Introduction

The rate of global deforestation and its impact on the environment has led particleboard manufacturers to search for alternative feedstock, especially in countries where wood is less available compared to other cellulosic natural products. The use of renewable resources such as agricultural residues, is gaining increased interest in production of particleboard. Rice husks are important byproduct of the rice milling process, which are available in fairly large quantities in certian agricultural areas. It is reported that about 0.23 tons of the rice husk are generated per ton of rice produced<sup>1</sup>. The main components of rice husk are cellulose (25 to 35%), hemicellulose (18 to 21%), lignin (26 to 31%), silica (15 to 17%), solubles (2 to 5%), and moisture content of 5-10%<sup>2</sup>. The reasons behind the use of rice husk in particleboard industry are its high availability, low bulk density (90-150 kg/m<sup>3</sup>), toughness, abrasive in nature, resistance to weathering and unique composition<sup>3</sup>. Although previous studies reported that rice husk particleboard could be used in the manufcture of furniture and interior fitments, the physical and mechanical properties of the particeboards were lower than those of the particleboards made from wood particles<sup>4-6</sup>. The main reasons for lower physical and mechanical properties of the rice husk particleboards are low aspect ratio and waxy/silica layer of the rice husk particles.

Polyethylene adhesives are milky white, translucent substances derived from ethylene  $(CH_{29}CH_2)$ . Low density polyethylene (LDPE) typically has long side-chain branching off the main molecular chain and therefore is a more amorphous polymer those branched polyethylene

plastics, having a standard density of 0.91-0.92 g/cm<sup>3</sup>. LDPE is the most widely used of all plastics, because it is inexpensive, chemical-resistant, very resistant to fungal attack, and have good dimensional stability when exposed to moisture<sup>7</sup>. Instead of urea-formaldehyde (UF) adhesive, LDPE offers many environmental and technological benefits when used as a binder for wood particles in the core layer of rice husk particleboard, such as no formaldehyde emission, higher water and fungal resistance.

The UF adhesive is one of the most common adhesives used in wood-based panel industry. Its low price and good strength properties of glue lines under dry conditions result in its being widely applied despite its low water resistance8. In order to increase water resistance of UF adhesives, they are commonly modified with melamine9 and diisocyanate<sup>10</sup>. Investigations conducted in this respect showed that the application of melamine and isocyanates in the UF adhesive improved the glue-line strength to a considerable degree and increased water resistance of the UF adhesive9,10. However, modifiers are still expensive and increase the cost of UF adhesive. Polyethylene matrix is extensively used in the production of lignocellulosic filled thermoplastic composites because it is high performance binder for lignocellulosics11-13. For this reason, LDPE could play an important role in the production of particleboard having a rice husk core.

When a particeboard is used in moist areas, it absorbs water. The core layer of particleboard is mainly responsible for thickness swelling (TS) and water absorption (WA) due to its high shell ratio. If the voids and spaces among the rice husk particles are filled by the melted LDPE, the dimensional stability of the particleboard can be improved. Internal bond strength of the particleboard having a rice husk core can be improved as the rice husk particles are encapsulated in the hydrophobic LDPE matrix. The objective of this study was to investigate the combined effect of liquid thermosetting adhesives (UF or phenol-formaldehyde (PF) adhesives) and powder thermoplastic adhesive (LDPE) on the dimensional stability and mechanical properties of three-layer particleboard. The particleboards were made from a mixture of rice husk particles (core layer: 70 wt%) and wood particles (face layer: 30 wt%). The wood particles used in the top and bottom layers were bonded with UF or PF adhesive while the core layer consisting of rice husk particles were bonded with a mixture of the thermosetting adhesives (UF or PF adhesive) and LDPE powder.

# 2. Experimental

## 2.1. Materials

The rice husk particles were obtained from a rice mill in Chuncheon, capital city of Gangwon Province, South Korea. The average moisture content of rice husk particles prior to the production of the particleboards was 5% based on the oven-dry weight of the rice husk particles. The average length, width, and thickness of rice husk particles used in the experiments were  $6.79\pm0.35$  mm,  $2.96\pm0.26$  mm,  $0.17\pm0.02$  mm, respectively (these values were an average of 30 the rice husks and standard deviation). The wood particles having a moisture content of 4-5% were obtained from a commercial particleboard company located in South Korea. The average length, width, and thickness of wood particles were  $13.53\pm3.72$  mm,  $1.95\pm0.74$  mm,  $0.97\pm0.40$  mm, respectively.

A commercial E1 (urea/formaldehyde ratio: 1/0.8, viscosity: 180 cps) grade liquid UF adhesive with a solid content of 56 wt% and liquid PF adhesive (viscosity: 195 cps) with a solid content of 59.4% were used in the production of the particleboards. The UF and PF adhesives were supplied by Hansolhomedeco company in Iksan city, South Korea. As a hardener 1% of ammonium chloride (NH<sub>4</sub>Cl) solution with 20 wt% solids content based on the UF adhesive solids content was added in to the UF adhesive solution. This study did not include the addition of any

external wax or water-repellent chemicals to the wood and rice husk particles.

The LDPE powder (particle size: 50 mesh, melting temperature = 105 °C, density = 0.926 g/cm<sup>3</sup>, MFI (melt flow index) = 24 g/10 min) was supplied by M.J Powder company in Ulsan city, South Korea.

# 2.2. Production of experimental particleboards

Three-layer particleboards consisting of a central layer (core) and two outer layers (faces) were manufactured under laboratory conditions (Figure 1). Both surfaces were made from the fine wood particles while the core layer was made from rice husk particles. The surface and core particles were separately placed in a drum blender. Then the UF adhesive was applied with an air-atomized metered spray system for 5 min to obtain a homogenized mixture. This procedure was also performed for the PF adhesive application. The LDPE powder was applied to the core particles with UF adhesive or PF adhesive. In the first phase, six levels of the LDPE powder (5-30 wt %) based on the composition by weight, were mixed with the core particles (rice husk) with 8 wt % UF adhesive. In the second phase, the LDPE powder content was kept constant at 10 wt% in all the treatments and the UF adhesive or PF adhesive contents applied to the core layer was decreased gradually from 8 to 4 wt%. The experimental design was presented in Table 1.

The layer construction of the particleboards based on the oven-dried weight ratio of the wood particles was 15:70:15 (face/core/face). The surface and core particles for three-layer boards were separately weighed and distributed evenly by hand into a 400 mm x 400 mm forming box. Release agent was used to avoid direct contact of the wood particles with the steel caul plates during heating and pressing. To reduce the mat height and to densify the mats, they were subjected to a cold-press. Particleboard mats having 10% moisture content were subjected to hot-press, using a manually controlled, electrically heated press. The hot press temperature, maximum pressure, and total press cycle were 180 °C, 2.5 N/mm<sup>2</sup>, and 5 min, respectively. The particleboards were then trimmed to a final size of 380 mm x 380 mm x 10 mm after the cooling process. A total of 72 particleboards, three for each type of formulation and control, were produced (Table 1). The average density values of the particleboards varied from 805 to 825 kg/m3.

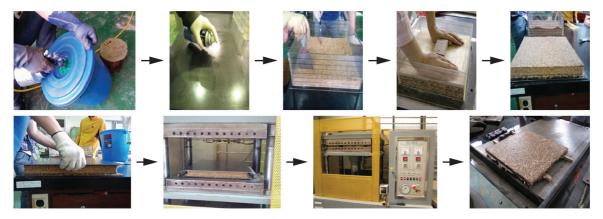


Figure 1. Laboratory-scale production of three-layer particleboards.

Particleboard type	Particleboard composition										
	Layer composition (% weight)		UF <sup>1</sup> adhesive content (% weight)		PF <sup>2</sup> adhesive content (% weight)		LDPE <sup>3</sup> powder content (% weight)				
	Surface layer: wood	Core layer: Rice husk	Surface	Core	Surface	Core	Surface	Core			
А	30	70	12	8	_	-	-	-			
В	30	65	12	8	-	-	-	5			
С	30	60	12	8	-	-	-	10			
D	30	55	12	8	-	-	-	15			
Е	30	50	12	8	-	-	-	20			
F	30	45	12	8	-	-	-	25			
G	30	40	12	8	-	-	-	30			
Н	30	70	-	-	12	8	-	-			
Ι	30	65	-	-	12	8	-	5			
J	30	60	-	-	12	8	-	10			
К	30	55	-	-	12	8	-	15			
L	30	50	-	-	12	8	-	20			
М	30	45	-	-	12	8	-	25			
Ν	30	40	-	-	12	8	-	30			
С	30	60	12	8	-	-	-	10			
0	30	60	12	7	-	-	-	10			
Р	30	60	12	6	-	-	-	10			
R	30	60	12	5	-	-	-	10			
S	30	60	12	4	-	-	-	10			
J	30	60	-	-	12	8	-	10			
Т	30	60	-	-	12	7	-	10			
U	30	60	-	-	12	6	-	10			
V	30	60	-	-	12	5	-	10			
W	30	60	-	-	12	4	-	10			

#### Table 1. Experimental design.

<sup>1</sup>UF: urea-formaldehyde. <sup>2</sup>PF: phenol-formaldehyde. <sup>3</sup>LDPE: Low density polyethylene.

Prior to the physical and mechanical tests all the specimens prepared from the particleboard the specimens were conditioned in a climatized room at 20°C and 65% relative humidity. Duration of the conditioning process was determined by regular weighing of the specimens until no changes in the weights were detected.

#### 2.3. Determination of dimensional stability

The TS and WA tests were carried out according to EN 317 (1993). Ten replicate specimens, 50 mm x 50 mm x 10 mm, from each type of particleboard were used for the TS and WA properties. At the end of 1-day of submersion, the specimens were taken out from the water and all surface water was removed with a clean dry cloth. The specimens were weighed to the nearest 0.01 g and measured to the nearest 0.001 mm immediately. The specimen thickness was determined by taking a measurement at a specific location, the diagonal crosspoint, on the specimen. The densities of specimens were evaluated according to the test method specified in EN 323 (1993).

# 2.4. Determination of mechanical properties

The bending strength (MOR) and modulus of elasticity (MOE) of the specimens were performed according to EN 310 (1993). A total of nine replicate specimens with dimensions of 250 mm x 50 mm x 10 mm were tested for

each type of particleboard. The bending tests were conducted in accordance with the third point loading method at a spanto-depth ratio of 20:1. The crosshead speed was adjusted so that the failure would occur within an average of  $60 \text{ s} \pm 10$ . The specimens were tested on Instron testing machine (Model: 4482) equipped with a load cell with a capacity of 10 kN. The internal bond (IB) strength tests were conducted on the specimens cut from the particleboards according to EN 319 (1993). Ten replicate specimens with dimensions of 50 mm x 50 mm x 10 mm from each type of paricleboard were used to determine the IB strength.

#### 2.5. Statistical analysis

An analysis of variance, ANOVA, was conducted (p < 0.01) to evaluate the effect of adhesive type and adhesive/ LDPE content on the physical and mechanical properties of the particleboards. Significant differences between the average values of types of the particleboards were determined using Duncan's multiple range test.

# 3. Results and discussion

#### 3.1. Dimensional stability

The TS and WA values of the particleboards are presented in Table 2. The dimensional stability of the specimens was greatly improved by increasing the LDPE

		Physical properties	5	Mechanical properties			
Particleboard type <sup>1</sup>	Density (g/cm³)	Thickness swelling (%)	Water absorption (%)	Modulus of rupture (MPa)	Modulus of elasticity (GPa)	Internal bond strength (MPa)	
А	820 (10)	102.9 (4.2) a <sup>2</sup>	95.5 (3.7) a	10.9 (0.8) a	2.13 (0.10) a	0.03 (0.005) a	
В	811 (17)	58.6 (2.5) b	85.9 (3.1) b	11.2 (0.7) ab	2.20 (0.08) ab	0.04 (0.005) af	
С	823 (12)	42.4 (2.2) c	68.9 (2.7) c	12.1 (0.9) bc	2.27 (0.10) ab	0.07 (0.007) bj	
D	806 (18)	33.6 (2.3) d	62.28 (2.4) d	12.9 (1.0) bcd	2.35 (0.08) bc	0.09 (0.006) bc	
Е	820 (20)	25.1 (1.9) e	56.0 (1.7) em	13.3 (0.8) cde	2.42 (0.05) cd	0.10 (0.005) cg	
F	810 (21)	16.1 (1.4) f	45.7 (2.0) fl	14.3 (0.9) def	2.50 (0.06) cd	0.12 (0.08) dg	
G	805 (25)	13.2 (1.2) g	39.2 (1.5) g	14.6 (1.1) def	2.51 (0.10) cd	0.14 (0.007) ehd	
Н	824 (24)	32.2 (1.3) d	70.1 (2.6) cj	13.6 (1.1) cde	2.22 (0.09) ab	0.05 (0.004) fi	
Ι	821 (18)	25.8 (1.5) e	57.8 (2.3) e	14.4 (0.9) def	2.35 (0.010) bc	0.05 (0.006) fi	
J	808 (20)	16.3 (0.8) f	42.8 (2.5) f	15.2 (1.0) fg	2.42 (0.011) cd	0.09 (0.008) cg	
K	818 (15)	13.2 (0.6) g	36.9 (1.7) g	15.6 (1.1) fg	2.49 (0.011) cd	0.11 (0.009) cg	
L	812 (23)	10.9 (0.6) h	27.3 (2.0) h	16.2 (1.3) gh	2.58 (0.011) d	0.13 (0.009) dh	
М	808 (15)	7.2 (0.4) i	21.3 (1.5) i	16.9 (1.2) gh	2.61 (0.09) d	0.15 (0.01) h	
Ν	822 (22)	6.3 (0.5) i	20.8 (1.8) i	17.4 (1.4) h	2.63 (0.012) d	0.19 (0.01) k	
С	823 (12)	42.4 (2.2) c	68.9 (2.7) c	12.1 (0.9) bc	2.27 (109) ab	0.07 (0.007) bj	
0	818 (16)	42.9 (1.9) c	69.6 (1.8) c	11.9 (1.0) ab	2.20 (113) a	0.06 (0.006) ji	
Р	821 (21)	43.8 (2.4) c	73.6 (2.8) j	11.2 (0.9) ab	2.15 (0.01) ab	0.05 (0.007) fi	
R	815 (18)	44.6 (2.1) c	73.7 (3.2) j	11.0 (1.1) ab	2.09 (0.09) a	0.04 (0.004) af	
S	813 (10)	49.4 (2.6) j	78.2 (3.6) k	10.9 (0.6) ab	2.04 (0.09) a	0.04 (0.005) af	
J	808 (20)	16.3 (0.8) f	42.8 (2.5) f	15.2 (1.0) fg	2.42 (0.11) cd	0.09 (0.008) c	
Т	819 (12)	19.3 (1.0) 1	46.9 (1.9) 1	15.0 (0.9) fg	2.39 (0.12) bc	0.08 (0.007) bc	
U	825 (16)	20.2 (0.6) 1	47.2 (2.2) 1	14.5 (0.7) def	2.31 (0.11) bc	0.06 (0.007) ji	
V	818 (21)	20.6 (0.9) 1	48.8 (1.5) 1	14.4 (0.9) def	2.24 (0.09) ab	0.05 (0.004) fi	
W	814 (14)	23.9 (0.7) e	52.8 (1.8) m	13.6 (0.6) cde	2.18 (0.08) ab	0.04 (0.003) af	

Table 2. Physical and mechanical properties of the particleboards.

<sup>1</sup> See Table 1 for particleboard formulation; <sup>2</sup> Groups with same letters in column indicate that there is no statistical difference (p<0.01) between the specimens according Duncan's multiply range test. The values in the parentheses are standard deviations.

content. Significant (p<0.01) differences were observed between the specimens with and without LDPE. The control specimens had much higher TS and WA values than the specimens containing the LDPE (Table 2). For example, the TS values of UF-bonded particeboards decreased from 102.9 to 58.6% as 5 wt% LDPE powder was incorporated into the core layer, and then decreased to 13.2% as the LDPE content increased up to 30 wt%. Similar results were found for the PF-bonded particleboards. It is well known that the PF adhesives are resistant to wet conditions whereas UF adhesives are not. As the LDPE is a good barrier to water due to its hydrophobic character, by replacing UF by LDPE, swelling thickness and water absorption are significatively reduced. The positive effect of LDPE on the TS and WA of particleboards was not significant between 25 and 30 wt% LDPE contents (Table 2).

The UF-bonded particleboards swelled more than two times higher than the PF-bonded particleboards at all loading levels of LDPE (Table 2). Hydroxymethyl phenols will crosslink on heating to around 120 °C to form methylene and methyl ether bridges through eliminating water molecules. At this point the PF adhesive is a 3-dimensional rigid network, which is typical of polymerised phenolic<sup>14</sup>. This makes the PF adhesive very resistant to water. However, the UF adhesive has lower water and weather resistance than the PF adhesive because aminomethylene linkages are susceptible to hydrolysis. Therefore, the UF adhesive is not stable at high humidity and temperature. Polycondensation of urea with formaldehyde usually results in hydrolytically sensitive bonds and low cross-link density which invariably increases sensitivity to losses in stress-bearing applications<sup>8</sup>.

The silica and waxy water repellent cuticle cover almost the entire outer layer of the rice husk<sup>15</sup>. The outer waxy layer of the rice husk particles has lower wettability. The silica in the husk is about 12% as ash content. The structure of silica was amorphous with a purity of 99.7%  $SiO_2^{[16]}$ . The adhesive could not efficienty wet and penetrate to the cellular structure of rice husk due to its waxy cuticle. This results in the poor interfacial adhesion between the rice husk particles, which increases thickness swelling and water absorption of the particleboards.

As the amounts of UF and PF adhesives decreased from 8 to 4 wt% at the same LDPE content (10 wt%), the TS and WA values of the particleboards increased. However, the TS and WA values of the particleboard containing LDPE were significantly lower than the control specimens (Table 2). For example, the TS and WA values of particleboards bonded with 4 wt% UF adhesive and 10 wt% LDPE were 49.4% and 78.2% while they were found to be 102.9% and 95.5% for the control particleboards bonded with 10 wt% UF adhesive, respectively. Similar results were observed for the PF-bonded particleboards. The decrease in the amount

of UF adhesive or PF adhesive resulted in higher TS values because swelling induced stresses caused the separation of the rice husk particles within the core layer.

#### 3.2. Mechanical properties

The incorporation of LDPE powder into the core layer of particleboard greatly improved the bonding between the rice husk particles. The IB values of particleboards increased by 366% and 280% as 30 wt% LDPE powder was incorporated into the core layer of UF- and PF-bonded particleboards, respectively. As compared to the control particleboards, the particeboards containing the LDPE powder, except for the particleboards containing 5 wt% LDPE, showed significant increases in the IB strength. Significant differences (p < 0.01) in the IB values are presented in Table 2 as letters. The increase in the amount of the LDPE powder considerably increased the IB strength because the LDPE powder led to better linkage between the rice husk particles. The polymer matrix used in the core layer acted as an adhesive to bond the rice husk particles together mechanically. The melted LDPE also improved the interfacial adhesion between core layer (rice husk particles) and face layers (wood particles) of the particleboard. Another explanation of this phenomenon was the uniform distribution of the melted LDPE over the rice husk particles. Similar results were found in previous studies regarding lignocelluosic filled thermoplastic composite panels17-19.

The IB strength of PF-bonded specimens was significantly higher than that of the UF-bonded specimens.

This revealed that the UF adhesive was more affected by the waxy silica layer compared with the PF adhesive. This is because the UF adhesive tends to have higher surface energy than the PF adhesive20. Although the IB strength of particleboards containing 10 wt% LDPE decreased with decreasing UF adhesive content in the core layer, it was higher than that of the control particleboards. For example, the average IB strength of the control particleboards was 0.03 N/mm<sup>2</sup> while it was found to be 0.04 N/mm<sup>2</sup> for the particleboards bonded with a mixture of 4 wt% UF adhesive and 10 wt% LDPE. The IB strength values of control and particleboards made with a mixture of 4 wt% UF adhesive and 10 wt% LDPE were found to be 0.05 N/mm<sup>2</sup> and 0.04 N/mm<sup>2</sup>, respectively. The IB strength of the particleboards containing 10 wt% LDPE powder decreased by 42.9% and 55.5% as the UF and PF adhesive contents decreased from 8 to 4%, respectively.

Different fracture modes were observed during the IB tests. The fracture modes of particleboard samples with and without LDPE were presented in the Figure 2. The weakest area of fracture resistance was found in the core layer of the control samples. As shown in Figure 2, the fracture for the control samples without the LDPE was occured in the core layer while this was observed in the layer between the core layer and face layer of the samples with the LDPE. This result revealed the bonding between the rice husk particles was significantly improved by the melted LDPE. The fracture surfaces of IB test samples with and without LDPE were presented in Figure 2.

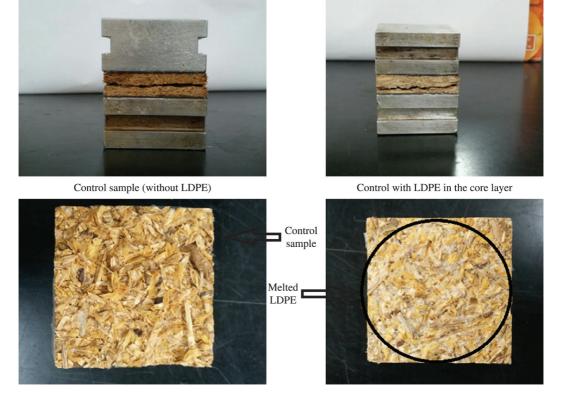


Figure 2. Fracture modes of the IB test samples with and without LDPE (top photos). The fracture surfaces of the IB test samples (below photos).

The MOR and MOE of the particleboards were significantly improved by the incorporation of LDPE into the core layer (Table 2). The incorporation of the LDPE into the rice husk core layer increased the bonding performance between the rice husk particles. The LDPE decreased the micro voids in the core layer of particleboard, which resulted in increased strength and modulus. As 30 wt% LDPE was incorporated into the core layer, the MOR of the UF- and PF-bonded particleboards increased by 33.9% and 27.9%, respectively. The MOE of UF- and PF-bonded particleboards increased by 17.7% and 18.6% as 30 wt% LDPE was incorporated into the core layer, respectively. The MOR and MOE of the particleboards having rice husk core with LDPE were comparable with particleboards made from wood particles. For example, Nasser<sup>21</sup> found that the MOR and MOE of three layer particleboards made from Pithecellobium dulce wood particles were 16.1 N/mm<sup>2</sup> and 2.56 GPa, respectively. In another study, Hiziroglu<sup>22</sup> determined that MOR and MOE of UF-bonded particleboard were 11.7 N/mm<sup>2</sup> and 2.04 GPa, respectively.

The change in the values of MOR and MOE of the particleboards was associated with the characteristics of the outer layer and the core layer. This was because the outer layer was the layer subjected to higher stress levels when the sample was under flexion state. In the samples A to G (or H to N) the amounts of thermoplastic adhesive increased in the core layer while the amount of rice husk decreased. Hence the total content of adhesive (thermosets and thermoplastics) increased. By increasing the content of adhesive, the value of MOE and MOR of boards improved slightly because only the core layer was modified.

The MOR and MOE of the particleboards containing 10 wt% LDPE decreased as the UF or PF adhesive content decreased from 8 to 4 wt% in the core layer (Table 2). This was due to the fact that the adhesives could effectively transfer and uniformly distribute stresses, thereby increasing the strength and stiffness of the particleboard. The MOR and MOE of particleboards containing 10 wt% the LDPE decreased with decreasing the amount of adhesive. However, there were no statistically significant differences in the MOR and MOE values of the particleboards as the UF

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adhesive content decreased from 8 to 4 wt% in the core layer. The MOR of UF-bonded particleboards containing 10 wt% LDPE decreased from 12.1 to 10.9 N/mm<sup>2</sup> as the UF adhesive content decreased from 8 to 4 wt% in the core layer. As for the PF-bonded particeboards, the MOR decreased from 15.2 to 13.6 N/mm<sup>2</sup> as the PF adhesive content decreased from 8 to 4 wt% in the core layer. The IB, MOR, and MOE values of the PF-bonded particleboards were higher than those of the UF-bonded particleboards.

# 4. Conclusions

The dimensional stability and mechanical properties of particleboards with rice husk core were significantly improved by the incorporation of LDPE into thecore layer. As the amounts of UF and PF adhesives decreased from 8 to 4 wt% at the same LDPE content (10 wt%), the TS and WA of the particeboards increased, but were significantly lower than those of the control specimens. The reason was that a hydrophilic material (RH) was replaced by a hydrophobic material (LDPE). Although the IB strength of particleboards containing 10 wt% LDPE decreased with decreasing UF adhesive content in the core layer, it was higher than that of the control particleboards. The MOR and MOE of the particleboards containing 10 wt% LDPE decreased with decreasing the amounts of UF and PF adhesives. However, there were no statistically significant differences in the MOR and MOE values of the particeboard types as the adhesive content decreased from 8 to 4 wt% in the core layer. Based on the findings obtained from the present study, it can be said that the rice husk particleboards containing LDPE, in particular above 20 wt% of LDPE, are suitable for use in damp places, such as bathrooms, toilets, kitchens, and laundries.

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